

S = 0.38 μ m GOLD/GXT
ON CONTACT AREA
2 μ m MIN MATTE
TIN ON TAIL

2µm MIN MATTE
TIN ON TAIL

G = 0.76μm GOLD/GXT
ON CONTACT AREA
2μm MIN MATTE
TIN ON TAIL

F = GOLD FASH
ON CONTACT AREA
2μm MIN MATTE

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC

UL 94V-0, COLOR BLACK

2. MATERIAL TERMINAL: COPPER ALLOY

3. TO DETERMINE DIMENSIONS:

N = NUMBER OF POSITIONS PER ROW

4. 7N MIN. PIN RETENTION IN EITHER DIRECTION.

5. PACKAGING:

= PLASTIC BOX

U = TUBE AVAILABLE FROM 06 TO 50 POS

6. ROHS COMPATIBLE PRODUCT SPECIFICATIONS

Q - PLATING:

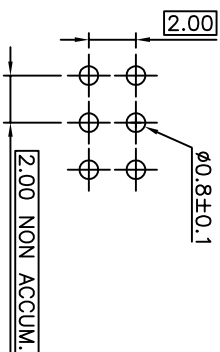
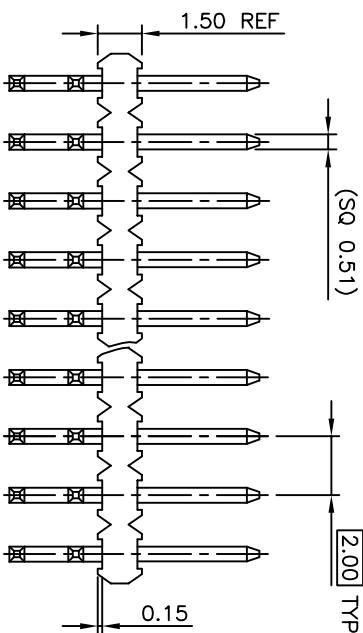
- "LF" MEANS THE PRODUCT IS LEAD-FREE, 2µm MINIMUM MATTE TIN OVER 1.27µm MINIMUM NICKEL UNDERPLATE.

b – MANUFACTURING PROCESS COMPATIBILITY

- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.

C - LABELLING:

- MEETS PACKAGING SPECS AS PER GS-14-920
- d - THIS PRODUCT MEETS EUROPEAN DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCIBED IN GS-47-0004



mat'l. code			surface			tolerance			projection			product family		
lthr	ecn	no	dr	date	ISO 1302	ISO 406	ISO 100	ISO 100	ISO 100	ISO 100	ISO 100	ISO 100	ISO 100	ISO 100
					tolerances unless otherwise specified									
A	F10338	LMU	03.10.01		angles		X	±0.3						
B	F04-0351	JCO	05.01.13				X,X	±0.15						
C	F06-0210	LMU	06.07.05				X,X	±0.03						
D	F08-0145	EIA	17.04.08	dr										
E	B-19190	LMU	14.10.24		ENGJ	COMPANION		04.09.28						
					CTR									
					QPPD	JM.C		04.09.28						
														
UNSHR HEADER														
RIGHT ANGLE TMT														
dwg no 98423 sheet 1 of 1														
size A3														
Type CUSTOMER Drawing														